

HD74HC93

4-bit Binary Counter

REJ03D0557-0200 (Previous ADE-205-430) Rev.2.00 Oct 06, 2005

Description

The HD74HC93 is a 4-bit ripple type counter consisting of four master/slave flip-flops that are internally connected to provide separate divide-by-two and divide-by-eight sections. Each section has a separate clock input which initiates state changes of the counter on the high-to-low clock transition. State changes of the Q outputs do not occur simultaneously because of internal ripple delays. Therefore, decoded output signals are subject to decoding spikes and should not be used as clocks or as strobes except when gated with the clock of the HD74HC93. Q_A is the output of the divide-by-two section; Q_B , Q_C , and Q_D are the binary outputs of the divide-by-eight section.

A gated AND asynchronous reset is provided which resets all the flip-flops.

Because the output from the divide-by-two section is not internally connected to the succeeding stages, the devices may be operated in various counting modes:

- 1. A 4-bit ripple counter The Q_A output must be externally connected to the clock B input. The input count pulses are applied to the clock A input. Simultaneous divisions of 2, 4, 8 and 16 are performed at the Q_A , Q_B , Q_C and Q_D outputs.
- 2. A 3-bit ripple counter The input count pulses are applied to the clock B input. Simultaneous frequency divisions of 2, 4 and 8 are available at the Q_B, Q_C and Q_D outputs. Independent use of the first flip-flop is available if the reset function coincides with reset of the 3-bit ripple-through counter.

Features

• High Speed Operation: t_{pd} (A to Q_A) = 13 ns typ (C_L = 50 pF)

• High Output Current: Fanout of 10 LSTTL Loads

• Wide Operating Voltage: $V_{CC} = 2 \text{ to } 6 \text{ V}$

• Low Input Current: 1 μA max

• Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max (Ta = 25°C)

• Ordering Information

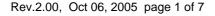
Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74HC93P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	Р	_
HD74HC93FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)
HD74HC93RPEL	SOP-14 pin (JEDEC)	PRSP0014DE-A (FP-14DNV)	RP	EL (2,500 pcs/reel)

Note: Please consult the sales office for the above package availability.

Function Table

Reset/Count Function Table

Reset	Inputs	Outputs						
R ₀₍₁₎	R ₀₍₂₎	\mathbf{Q}_{D}	Q_A					
Н	Н	L	L	L	L			
L	Х	Count						
Х	L	Count						





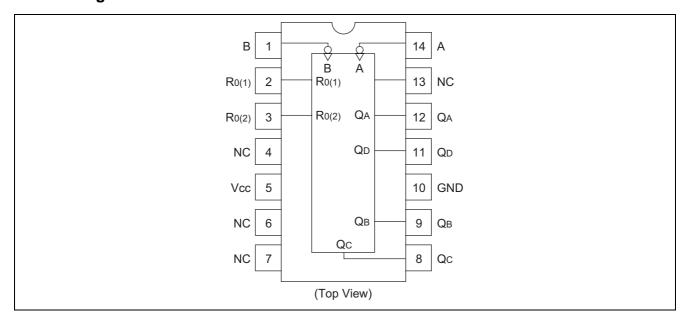
BCD Count Sequence

	Outputs							
Count	Q_D	Q _C	Q _B	Q_A				
0	L	L	L	L				
1	L	L	L	Н				
2	L	L	Н	L				
3	L	L	Н	Н				
4	L	Н	L	L				
5	L	Н	L	Н				
6	L	Н	Н	L				
7	L	Н	Н	Н				
8	Н	L	L	L				
9	Н	L	L	Н				
10	Н	L	Н	L				
11	Н	L	Н	Н				
12	Н	Н	L	L				
13	Н	Н	L	Н				
14	Н	Н	Н	L				
15	Н	Н	Н	Н				

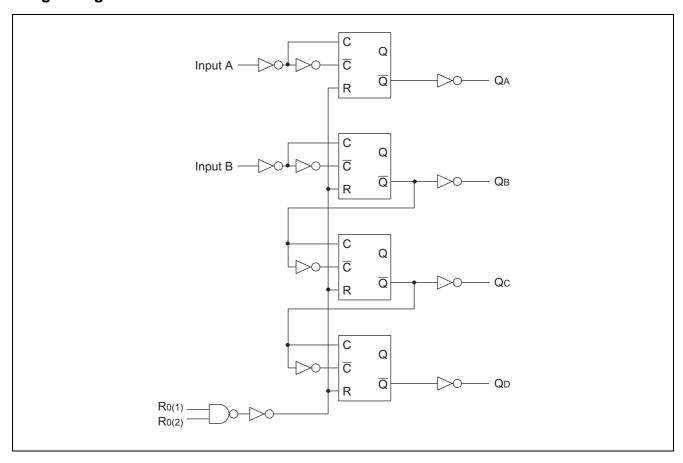
Note: Output Q_A is connected to input B for BCD count.

H: High levelL: Low levelX: Irrelevant

Pin Arrangement



Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	
Supply voltage range	Vcc	-0.5 to 7.0	V	
Input / Output voltage	Vin, Vout	−0.5 to V _{CC} +0.5	V	
Input / Output diode current	I _{IK} , I _{OK}	±20	mA	
Output current	I ₀	±25	mA	
V _{CC} , GND current	I _{CC} or I _{GND}	±50	mA	
Power dissipation	P _T	500	mW	
Storage temperature	Tstg	-65 to +150	°C	

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{CC}	2 to 6	V	
Input / Output voltage	V _{IN} , V _{OUT}	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	
		0 to 1000		V _{CC} = 2.0 V
Input rise / fall time ^{*1}	t _r , t _f	0 to 500	ns	V _{CC} = 4.5 V
		0 to 400		$V_{CC} = 6.0 \text{ V}$

Note: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

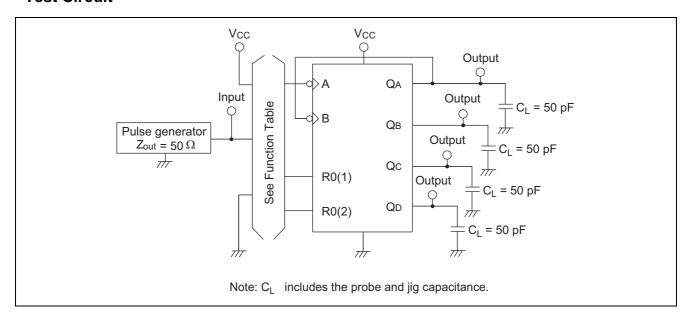
Electrical Characteristics

			Т	a = 25°C Ta = -40 to+85°C						
Item	Symbol	V _{cc} (V)	Min	Тур	Max	Min	Max	Unit	Test Cor	nditions
Input voltage	V _{IH}	2.0	1.5	_	_	1.5	_	V		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2	_		4.2	_			
	V_{IL}	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35			
		6.0	_	_	1.8	_	1.8			
Output voltage	V_{OH}	2.0	1.9	2.0	_	1.9	_	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -20 \mu A$
		4.5	4.4	4.5	_	4.4	_			
		6.0	5.9	6.0	_	5.9	_			
		4.5	4.18	_	_	4.13	_			$I_{OH} = -4 \text{ mA}$
		6.0	5.68	_	_	5.63	_			$I_{OH} = -5.2 \text{ mA}$
	V _{OL}	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OL} = 20 \mu A$
		4.5	_	0.0	0.1	_	0.1			
		6.0	_	0.0	0.1	_	0.1			
		4.5	_	_	0.26	_	0.33			$I_{OL} = 4 \text{ mA}$
		6.0	_	_	0.26	_	0.33			$I_{OL} = 5.2 \text{ mA}$
Input current	lin	6.0	_	_	±0.1		±1.0	μΑ	Vin = V _{CC} or GND	
Quiescent supply current	Icc	6.0	_	_	4.0	_	40	μΑ	Vin = V _{CC} or GN	ID, lout = $0 \mu A$

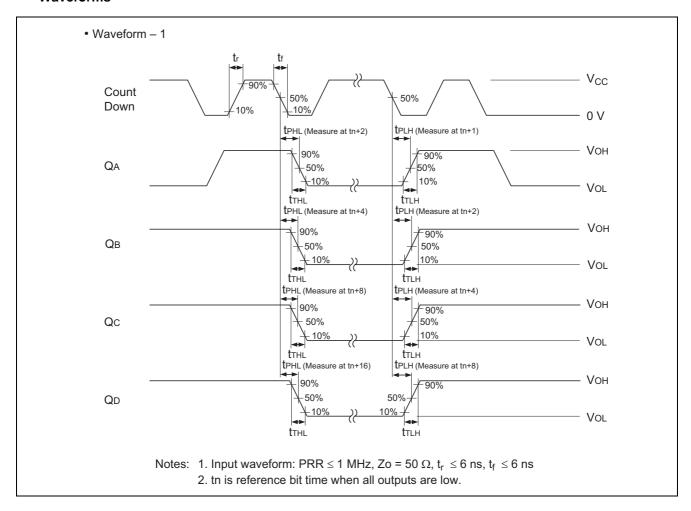
Switching Characteristics ($C_L = 50 \text{ pF}$, Input $t_r = t_f = 6 \text{ ns}$)

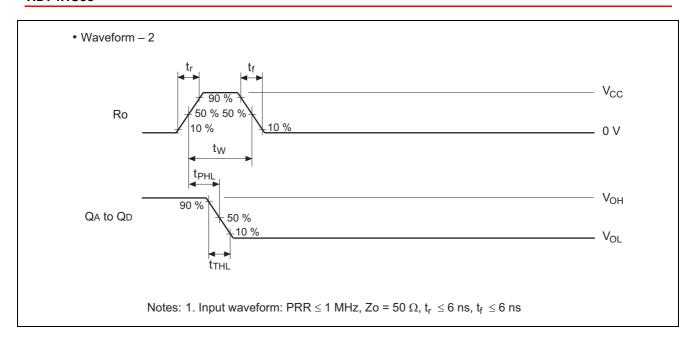
			Т	a = 25°	С	Ta = -40	to +85°C		
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f _{max}	2.0		_	5	_	4	MHz	
Frequency		4.5		_	27	_	21		
		6.0		_	32	_	25		
Propagation delay	t _{PLH} , t _{PHL}	2.0		_	120	_	150	ns	A to Q _A
time		4.5		13	24	_	30		
		6.0		_	20	_	26		
	t _{PLH} , t _{PHL}	2.0		_	340	_	425	ns	A to Q _D
		4.5		42	68	_	85		
		6.0		_	58	_	72		
	t _{PLH} , t _{PHL}	2.0		_	130	_	165	ns	B to Q _B
		4.5	_	13	26	_	33		
		6.0	_	_	22	_	28		
	t _{PLH} , t _{PHL}	2.0	_	_	185	_	230	ns	B to Q _C
		4.5	_	21	37	_	46		
		6.0	_	_	31	_	39		
	t _{PLH} , t _{PHL}	2.0	_	_	220	_	275	ns	B to Q _D
		4.5	_	27	44	_	55		
		6.0	_	_	37	_	47		
	t _{PLH} , t _{PHL}	2.0	_	_	175	_	220	ns	Set-to-0 to Q _{A to D}
		4.5	_	13	35	_	44		
		6.0	_	_	30	_	37		
Output fall time	t _{TLH} , t _{THL}	2.0	l	_	75	_	95	ns	
		4.5	l	5	15	_	19		
		6.0		_	13	_	16		
Input capacitance	Cin	_	_	5	10	_	10	pF	

Test Circuit

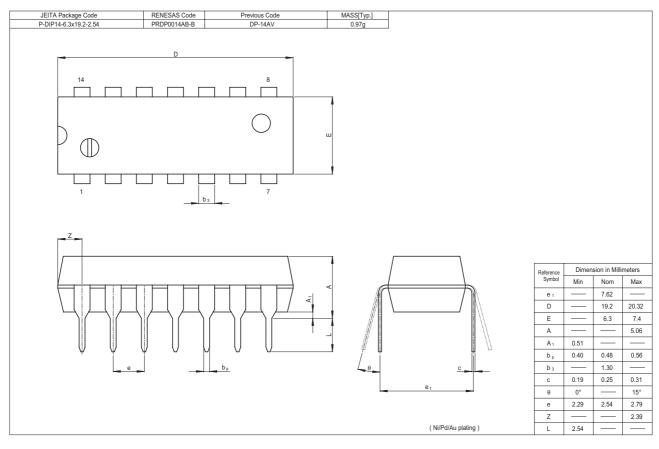


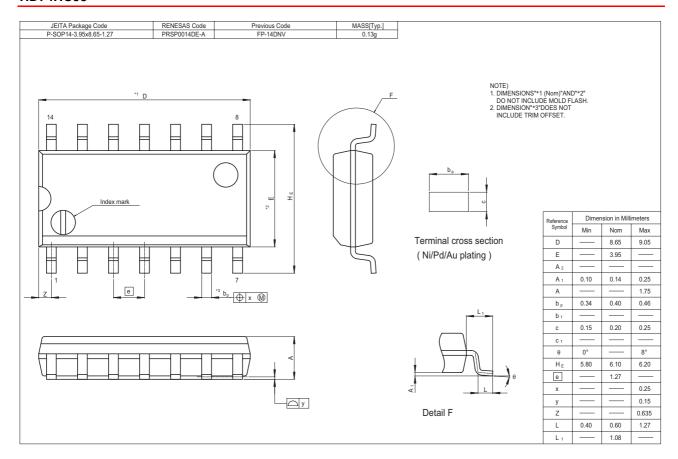
Waveforms

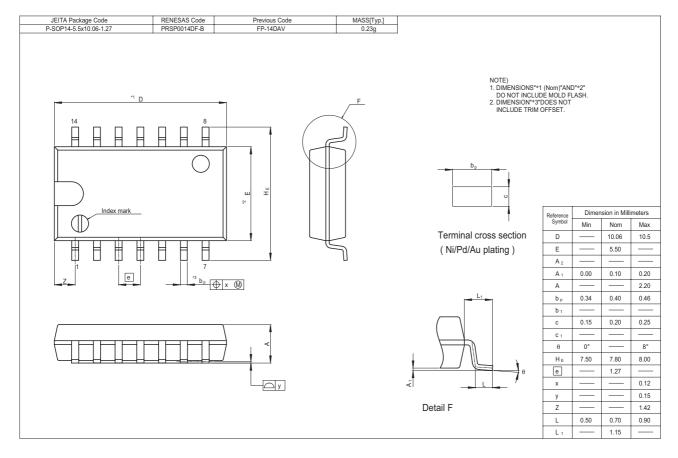




Package Dimensions







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